

The Shrink Wrapped Myth:

Cross Platform Software

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Mike Olivarez



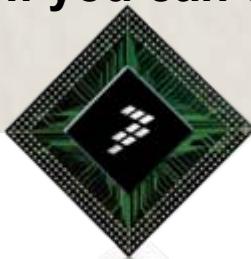
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Embedded Software Definition

- Embedded software is thought of as that for non general purpose processing computers with few applications.
- The evolving definition of embedded systems.
 - Microcontroller – “The Elevator” sequence... Everywhere
 - Engine/Sensor Control – Sensor networks and response
 - Networking and wireless – Protocol stacks and translations, data server, security
 - Consumer Electronics – A world of possibilities...
 - Robotics
 - Media Players
 - Cellular
 - Crossovers – Smart Phone, MID: is it a computer or an embedded system?
- **If you can dream it... we can embed it!**



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Issues With Shrink Wrap Software



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- Getting the most of the system = efficiency
 - Performance (speed and power) is more than just the hardware
- Once the hardware architecture is set, efficiency is set by the software
 - **Option 1) Hand Coded Assembly**
 - Pros:
 - Highly efficient code based on system constraints for speed
 - Efficient with memory utilization
 - Easy to take full advantage of the architecture
 - Cons:
 - Time Consuming
 - Not portable, architecture dependant
 - **Option 2) Compiler Efficiency**
 - Pros:
 - Higher level of abstraction for code, more portable
 - Faster development, time to money
 - Cons:
 - May not be as efficient or use all the capabilities of the architecture
 - May require more memory



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Efficiency Processor A

5 Stage Pipeline

- Cycles per Instruction (CPI):

RISC Processor A	Instruction %	Compiler Efficiency	Instructions by Type (millions)	Pipeline Penalty Cycles	CPI Penalty
ALU Instructions	40%	100%	471	0.000	0.000
Loads	25%	80%	294	0.465	0.116
Stores	15%	88%	177	0.120	0.018
Branches	20%	50%	235	0.825	0.165
Total				Cycles	CPI
	100%		1177	1529	1.30

- Pipeline Penalty Cycles Calculation:
 - Cycles = $\Sigma(\text{Instructions} + (\text{Instructions} * \text{Pipeline Penalty}))$
- CPI Penalty Calculation:
 - CPI = $1 + \Sigma(\text{Instruction \%} * \text{Pipeline Penalty Cycles})$



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Efficiency Processor B

8 Stage Pipeline

- Cycles per Instruction (CPI):

RISC Processor B	Instruction %	Compiler Efficiency	Instructions by Type (millions)	Pipeline Penalty Cycles	CPI Penalty
ALU Instructions	40%	130%	471	-0.300	-0.120
Loads	25%	80%	294	0.465	0.116
Stores	15%	100%	177	0.000	0.000
Branches	20%	80%	235	0.726	0.145
Total				Cycles	CPI
	100%		1177	1343	1.14

- Differences in Processor A and Processor B
 - SIMD adding efficiency for ALU Instructions
 - Backside Cache for Stores
 - Branch Prediction enhancements
 - Pipeline Stages – breaking down the work done in smaller chunks to increase clock speed.

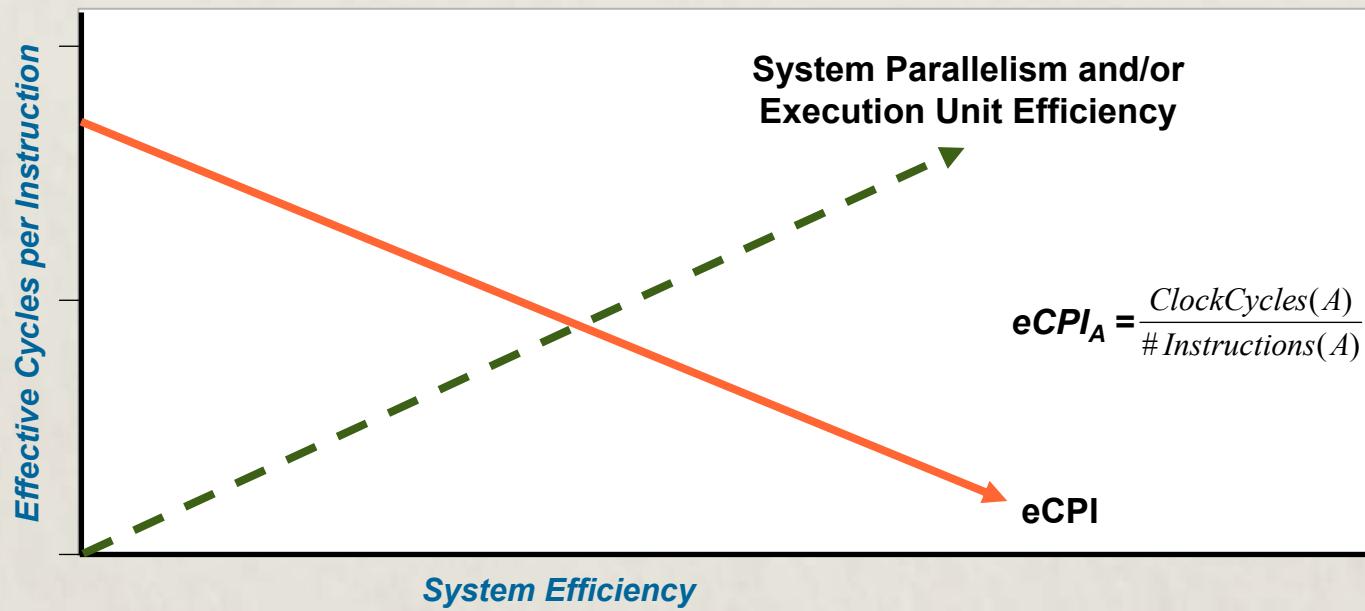


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Effective Cycles per Instruction

- Cycles per Instruction (CPI) is an effective measurement of how much computational work is being done per clock cycle, to compare architectures
- Effective CPI (eCPI) is a method which allows for dissimilar architectures to be compared, with a baseline for the number of instructions needed for a specified task



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Improvements through Parallelism

- *Improvement in the application due to parallelism is dependant on the sequential portion.* - Amdahl's Law
 - Essentially based on single or symmetric multi-core solution.
- Embedded System Solutions:
 - Adding Specialized Execution Units
 - Take advantage of the Architecture
 - Speeding up the limiting factors
 - Synchronous vs. Asynchronous Processing
 - Compiler and OS environments to take advantage of the architectural differences.



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Compiler: Getting the Most of the Processor

- Compiler needed to take advantage of the architecture
 - Without the changes, the advantages of SIMD can't be used.
 - Branch Prediction Unit may not be as efficient
 - Instruction Sequence may not take advantage of the Pipeline
- Using Processor B without the change in the Compiler may not run the application faster.
- **Compiler is an integral part of the System Design.**

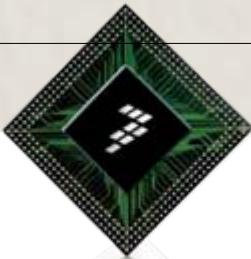


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Operating System Examples

- “RTOS”
 - Vertex/Nucleus
 - QNX
 - RTXC
 - RTLinux
 - pSOS
 - LynxOS
 - eCos
 - μC/OS
 - many, many more...
- Easier to tune for few applications
- Few if any additional layers
 - Complexity added to applications

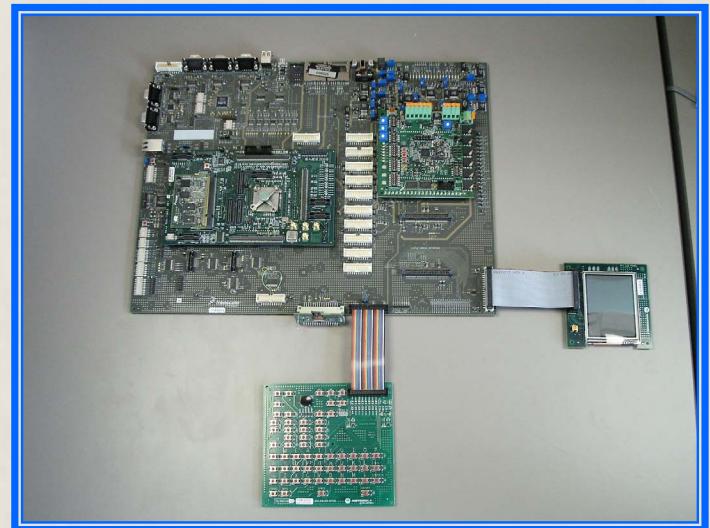


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- Open OS
 - Linux
 - Android
 - Palm Web OS
 - LiMo
 - etc...
 - Windows CE/Mobile
 - Symbian
 - BlackBerry OS
 - iPhone OS
- Easy to port new apps
 - Layers to ease porting
- APIs for code reuse
 - Well documented APIs
 - Complexity abstracted from applications

- Application debugging
 - System Processor
 - From one to many processors
 - Symmetric and Asymmetric Processing
 - Multiple of instantiations of the same Processing Elements
 - Instantiations of different Processing Elements
 - Code Traces and Profiling
 - System Debugging
 - System Peripherals
 - Interfaces, Buttons and Displays
 - Man/Machine Interface
 - Machine/Machine Interface



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Modeling and Simulation

- Model Creation
 - Instruction Set Simulator
 - Peripheral Simulator
 - Levels of Abstraction
 - Statistical Model
 - Cycle Approximate
- Model Uses
 - System Specification
 - Performance Estimation
 - Bandwidth Analysis
 - Early Code Generation



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Freescale's MXC300-30.1 Platform Example

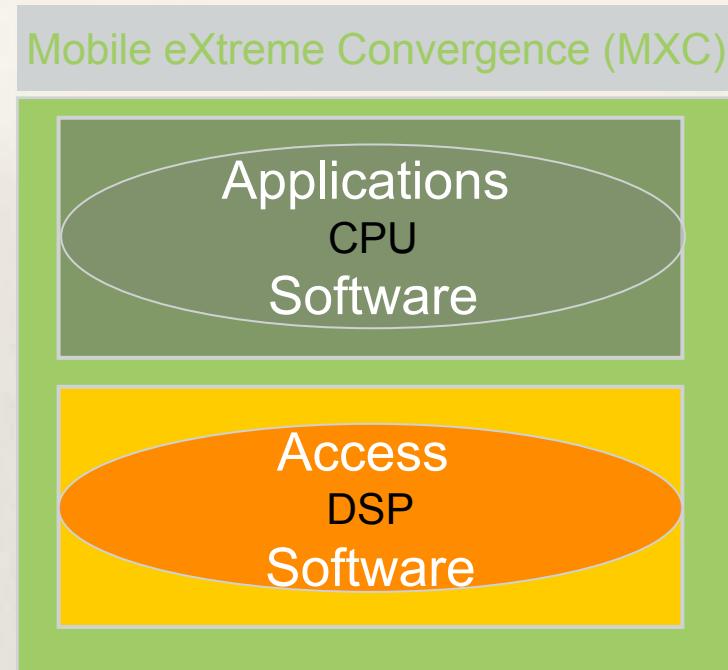
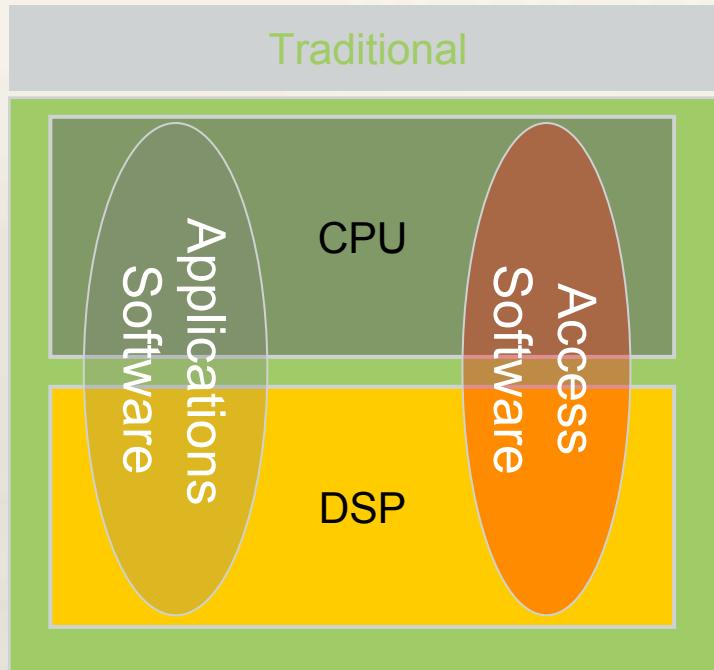


Because of an order from the United States International Trade Commission, BGA-packaged product lines and part numbers indicated here currently are not available from Freescale for import or sale in the United States prior to September 2010: MXC91321, MXC300-30.1

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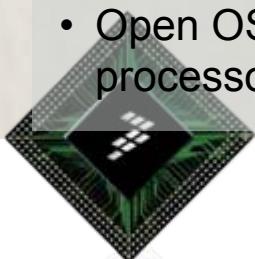


Value Proposition - Mobile eXtreme Convergence (MXC)



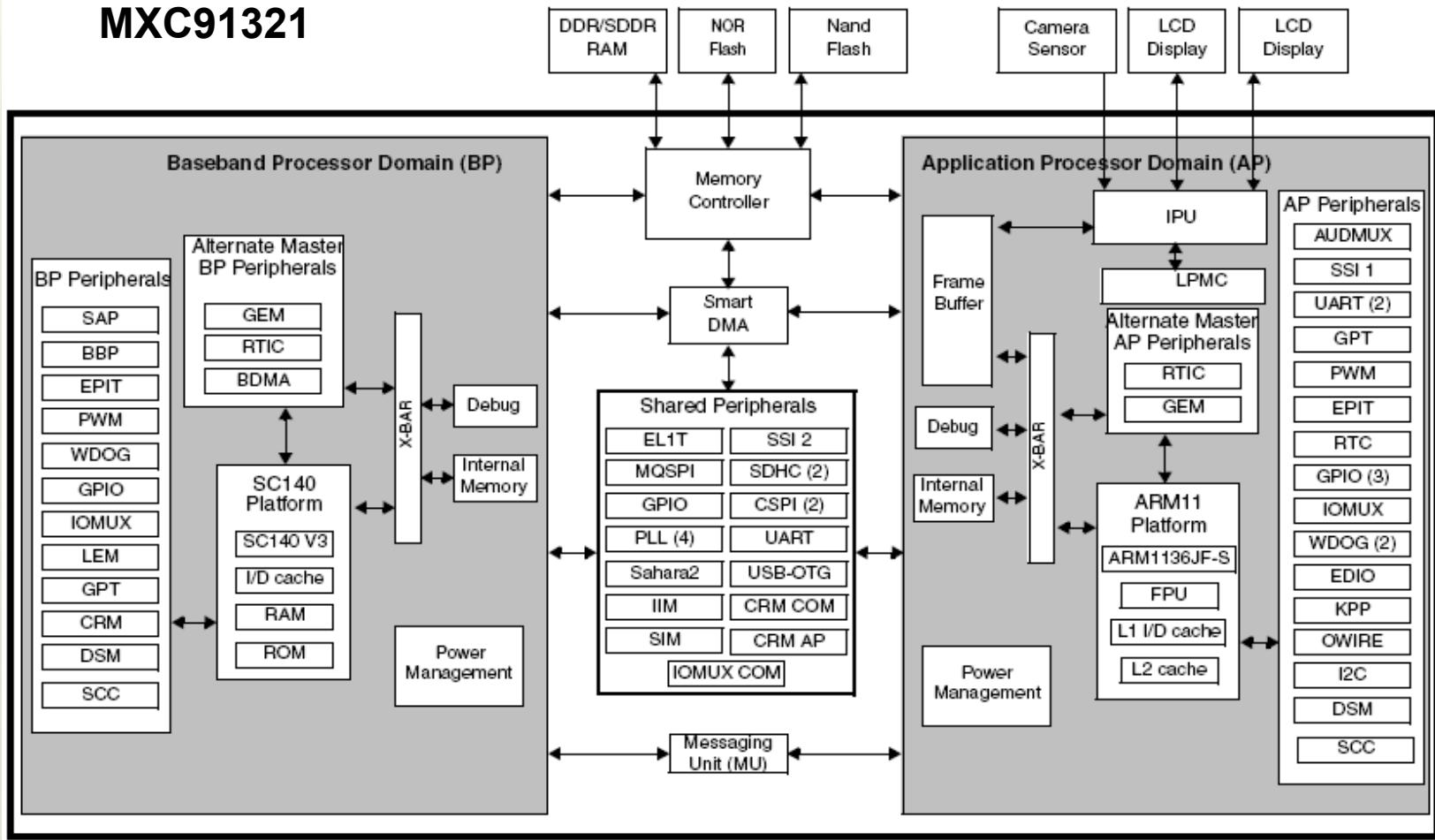
- Shared resource conflicts
- Difficult integration of 2 OS
- Difficult to scale
- Open OS can require extra processor and memory

- Clean separation of domains
- Simpler integration of 2 OS
- Easy to scale / tier
- More secure
- Enables separate modem / Apps



MXC Architecture Overview

MXC91321



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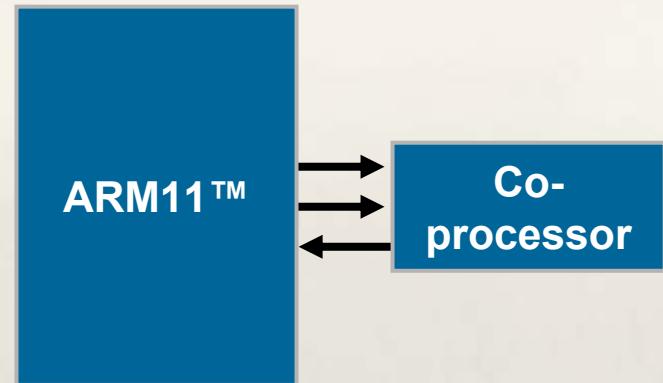
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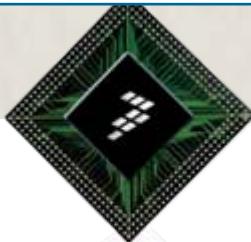
Specification Difference

Creating the Specification Model helps answer:

- Will the behavior be needed in the system, based on the proposed use cases?
- What is the benefit of the behavior?
- What are should be the specification for the behavior?



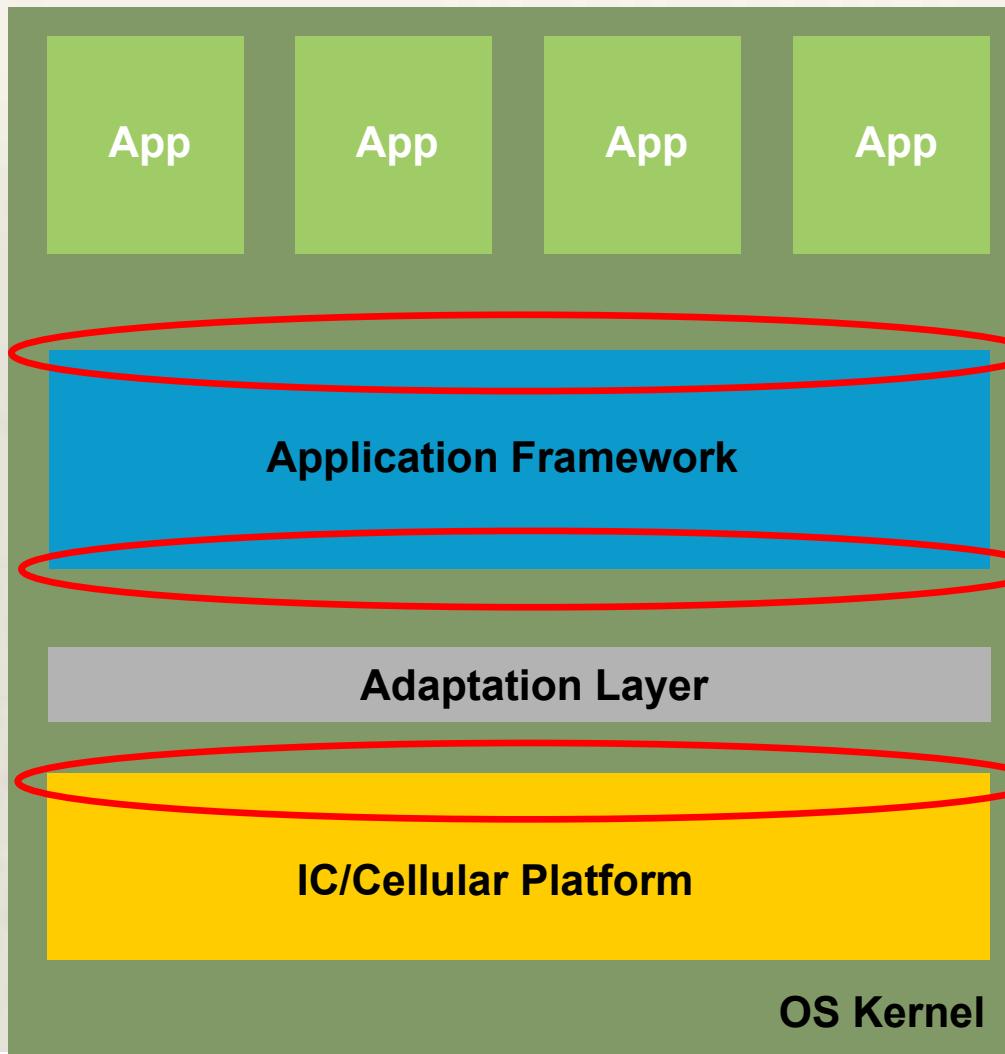
Improvements over Floating Point Software	Floating Point Hardware Improvement Percentage	Fixed Point Software Improvement Percentage
Application Cycles	825 %	837 %
Floating Point calculation cycles	1525 %	793 %
Instructions issues for Floating Point Calculations	2223 %	923 %
Application energy savings	83 %	88 %
Floating Point calculation energy savings	91 %	88 %
Code memory footprint savings	16 %	16 %
Arithmetic code development time	15 min	~120 min



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Open OS Cellular Software Layering

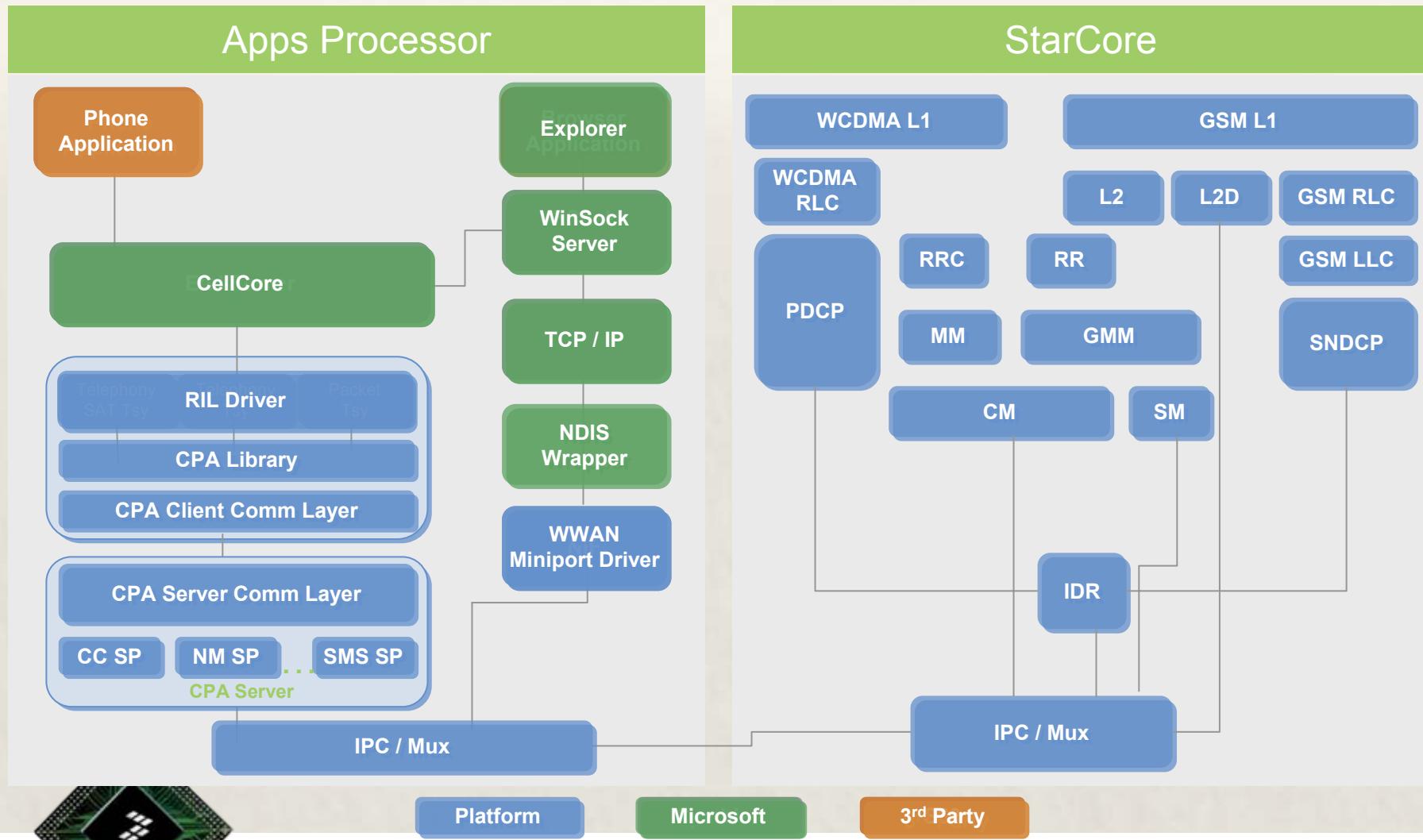


**Application
Programming
Interface**

**OS/App FW defined, platform
integration Interface**

**OS Independent Common
Platform Interface, e.g., CPA**

Cellular Platform Access (CPA) Abstraction Layer For OS Flexibility



The Shrink Wrapped Myth

- “Silicon without software is just sand” - Todd Conroy, Freescale Semiconductor
 - Software defines the usability.
 - Optimization of the code is critical to performance.
 - Operating System is an critical part of the System Design.
 - Software is an integral portion of the MXC platform to allow for small devices to provide a great user experience.



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Thank You

